

Description

Yantel's surface mount catalog bandpass filters utilize Yantel's low loss temperature stable materials which offer small size and minimal performance variation over temperature. The catalog BPF's are offered in a variety of frequency bands, which offers a drop in solution with highly repeatable performance.

Features

- Small Size
- Fully Shielded Component
- Solder Surface Mount Package
- Moisture Sensitivity Level: MSL1
- Frequency Stable over Temperature
- Operating & Storage Temp: -55°C to +125°C
- Characteristic Impedance: 50Ω

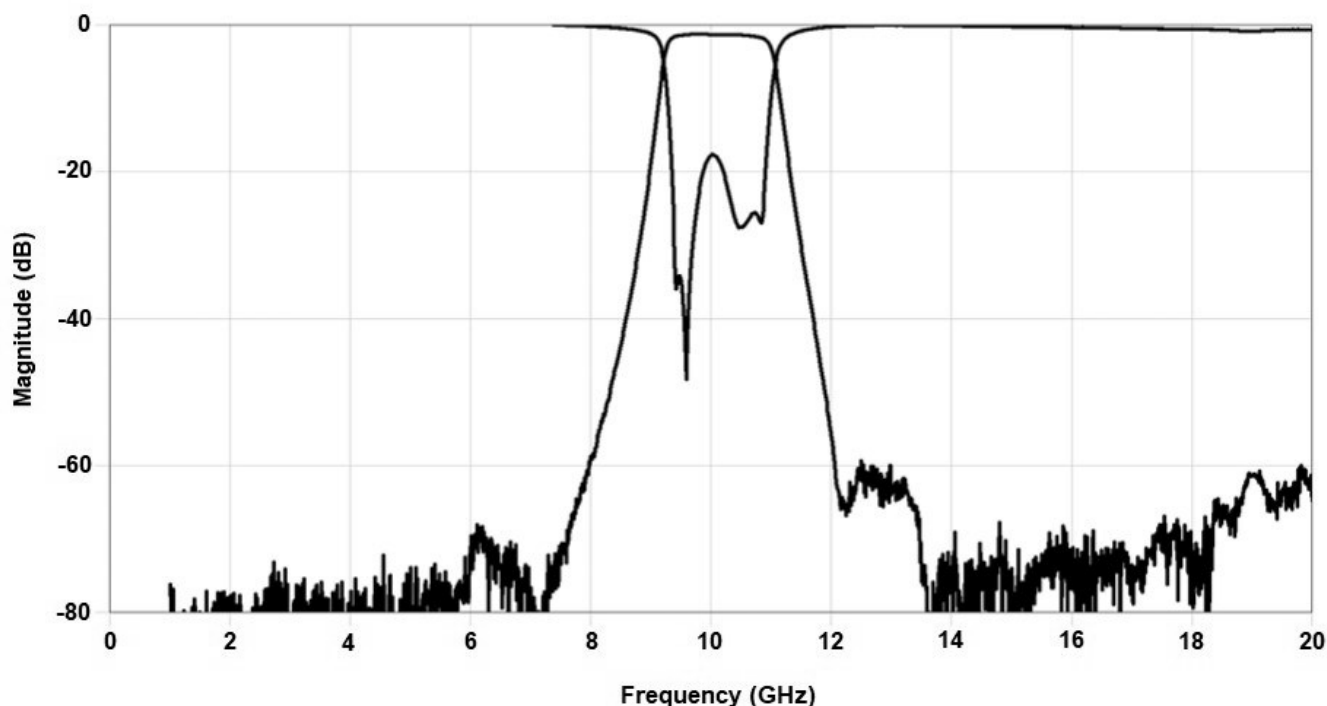
Specifications*

Parameter	Frequency Range (GHz)	Min	Typ.	Max
Insertion Loss (dB)	9.5 - 10.5		2.0	2.5
Return Loss (dB)		10.0	14.0	
Low Side Rejection (dB)	DC - 8.25	40.0	50.0	
High Side Rejection (dB)	11.75 - 20.0	40.0	40.0	
CW Input Power** (W)				10
$\theta_{JC} \left(\frac{^{\circ}\text{C}}{\text{W}} \right)$	7.5			
Size (L x W x H)	10.16 x 3.81 x 2.62 mm			

*Electrical specifications based on typical probed performance at room temperature. Insertion loss shall vary ± 0.5 dB over temperature.

**Power rating assumes the component will be mounted to a PCB with good thermally conducting ground vias as outlined in the recommended PCB layout that are connected to an adequate heat sink. Max power is based on 125°C base temperature.

Typical Measured Performance



*Typical de-embedded measured performance mounted on a connectorized test fixture. DEB is 0.254mm RO4350B with 50.0Ω CPW ground traces going into the ports at room temperature.

Yantel Corporation

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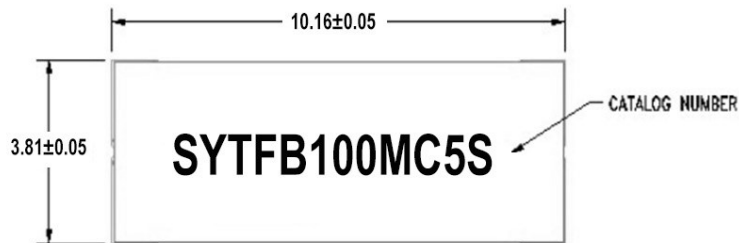
Tel: 86-755-8355-1886 Fax: 86-755-8355-2533

For detailed performance specs & shopping online see Yantel web site : www.yantel-corp.com

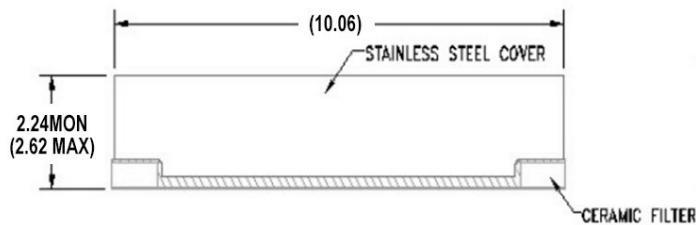
Physical Dimensions

Units = mm

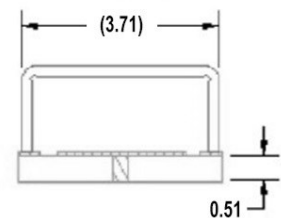
Top View



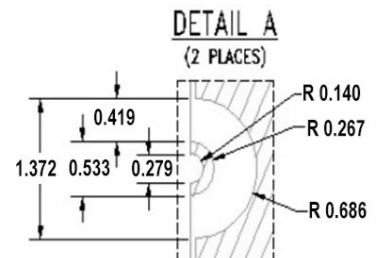
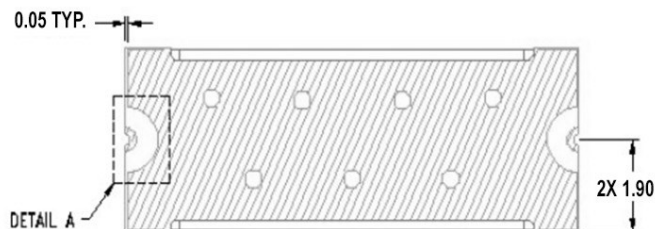
Side View



End View



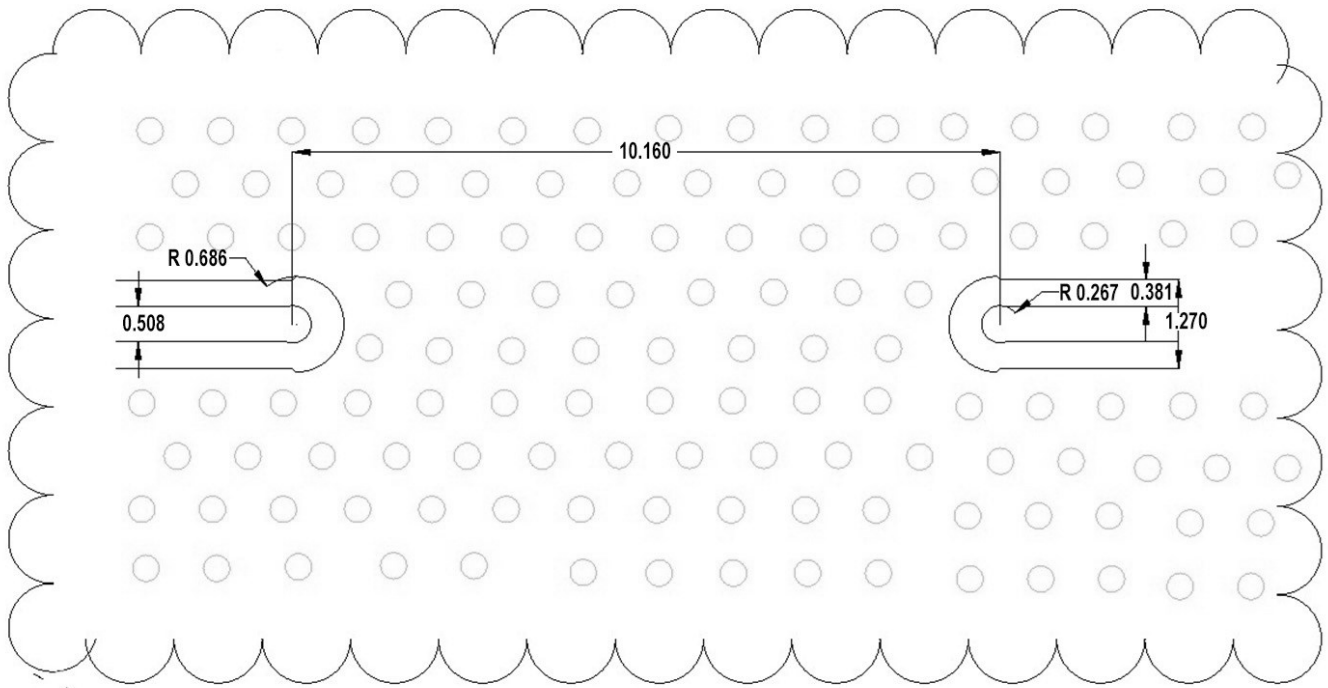
Bottom View



Notes :

1. Termination Finish:
ENIG: 76-152 μm Au over 1270 μm Ni
2. Maximum Assembly Process Temperature: 250°C
3. Dimension tolerance: ± 0.05

Recommended PCB Layout



Unit =mm

Note:

- 50 Ω trace dimensions are application specific.
- Ensure adequate grounding beneath the part.